

Product Change Notification



PMG - Microelectronics (also DBA as White Electronic Designs Co.) is a wholly owned subsidiary of Microsemi Corp.

Date: FRIDAY, NOVEMBER 22, 2013

PCN#: 140A00219

Subject: Part number changes

Product Description: 208 PBGA DDR SDRAM

Dear Customers,

Microsemi Power and Microelectronics Group (PMG) would like to notify you of the package height changes due to the die revision changes. As a result, PMG has assigned the following new part numbers:

Product Description	Current Part Number	Die Type	Current Pkg Max Thick (mm)	New Part Number	Die Type	New Pkg Max Thick (mm)
256MB – 32Mx72	W3E32M72S-XSBX	Current	3.20	W3E32M72S-XB3X	New Shrink	2.26
256MB – 32Mx64	W3E32M64S-XSBX		2.32	W3E32M64S-XB3X		2.26
256MB – 32Mx72	W3E32M72SR-XSBX		3.12	W3E32M72SR-XB3X		2.27

Microsemi has a limited supply of the current die. Based on the current die supply, product will be available on a first come first serve basis. The new datasheet will be available on Microsemi's website. Please contact your Sales representative for questions related to this change.

Best regards,

Microsemi Power and Microelectronics Group Engineering